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(54) **HEAT DISSIPATOR FOR A NOTEBOOK COMPUTER**

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**Related U.S. Patent Documents**

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Filed: **Oct. 16, 2006**

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D14/451, 452, 457, 460, 328, 324, 405; D6/300,  
D6/310, 311, 312, 419, 449, 512, 513; D19/20,  
D19/89, 90, 91; 108/10, 28, 32, 6; 248/442.2,  
248/454, 457, 460, 371, 447, 393, 398, 127,  
248/133, 136, 178.1, 455, 349.1, 346.03,  
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248/441.1, 917, 918, 919, 920, 921, 922,  
248/923, 924; 361/683, 686

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for heat dissipator for a notebook computer, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a heat dissipator for a notebook computer in accordance with the invention;  
FIG. 2 is a front elevational view of the heat dissipator;  
FIG. 3 is a rear elevational view of the heat dissipator;  
FIG. 4 is a left side elevational view of the heat dissipator;  
FIG. 5 is a right side elevational view of the heat dissipator;  
FIG. 6 is a top plan view of the heat dissipator; and,  
FIG. 7 is a bottom plan view of the heat dissipator.

**1 Claim, 5 Drawing Sheets**

**Matter enclosed in heavy brackets [ ] appears in the original patent, but forms no part of this reissue specification; matter printed in italics indicates the additions made by reissue.**

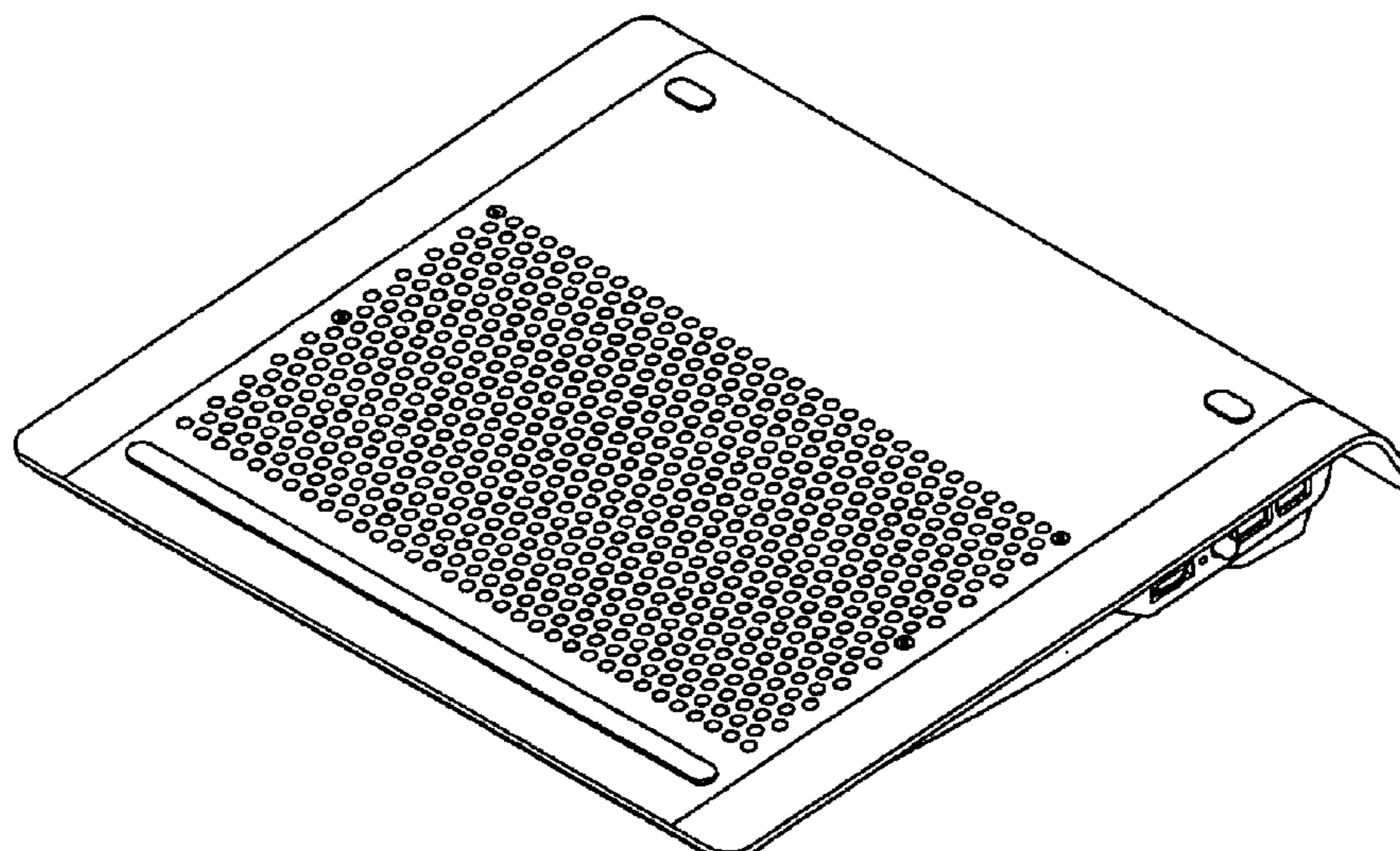


FIG. 1

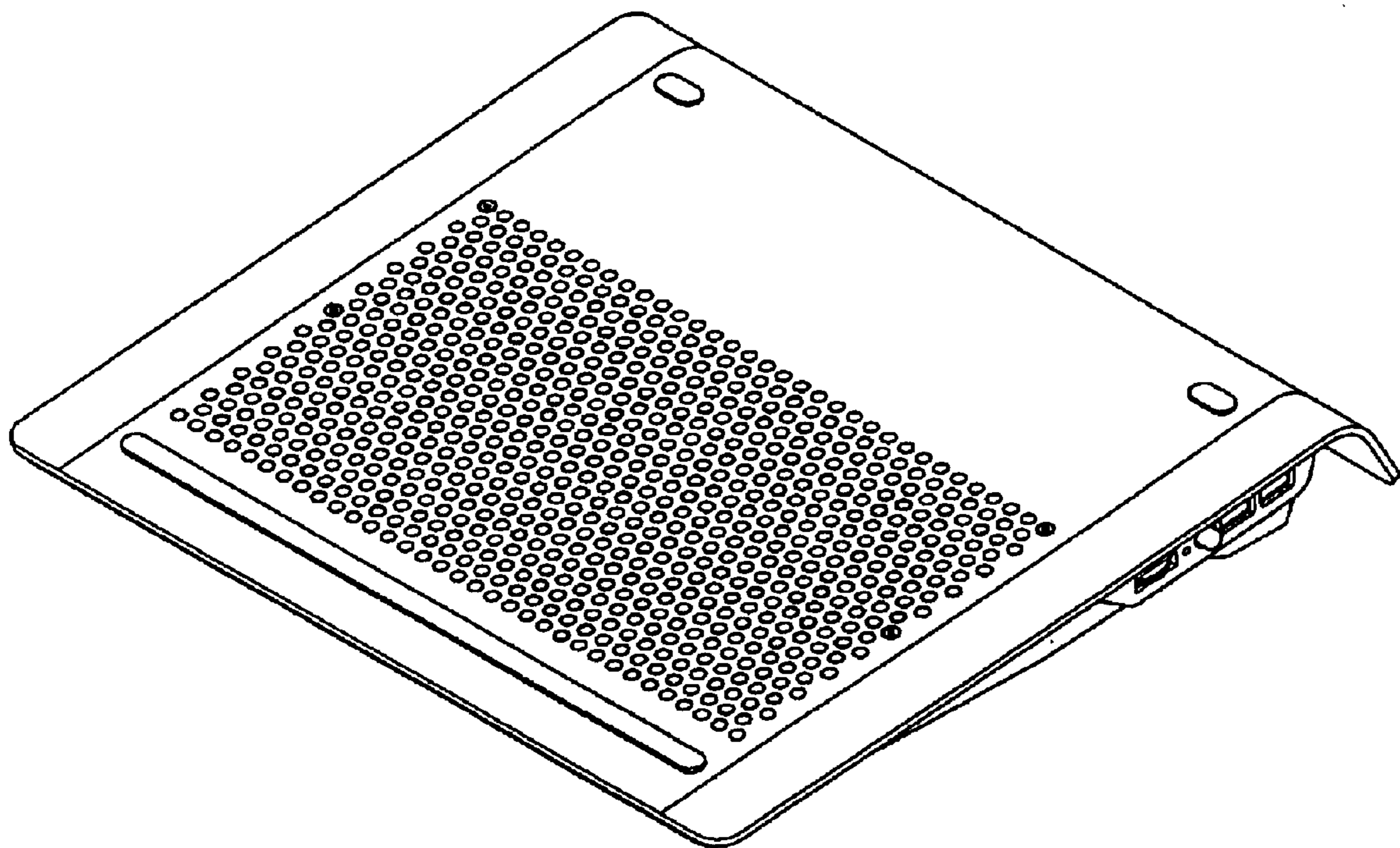


FIG. 2

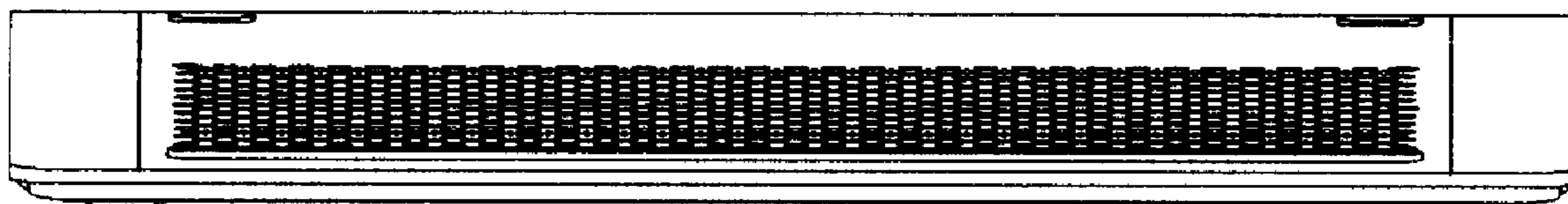


FIG. 3 (Amended)

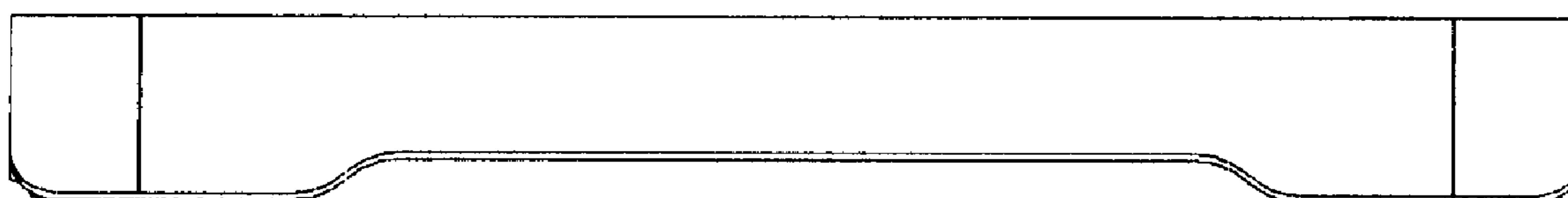


FIG. 4

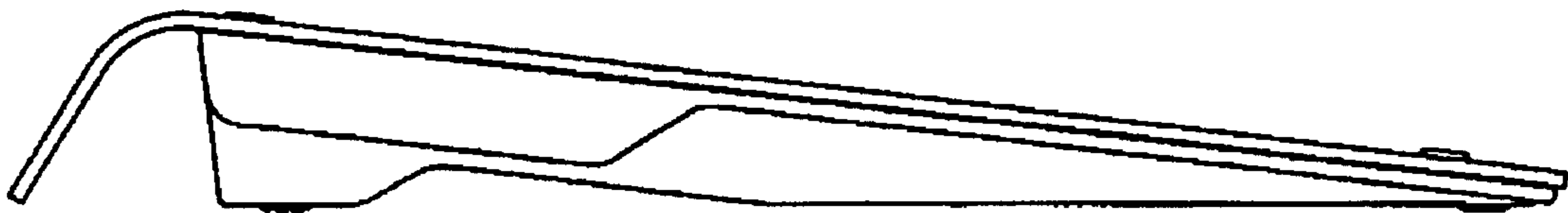
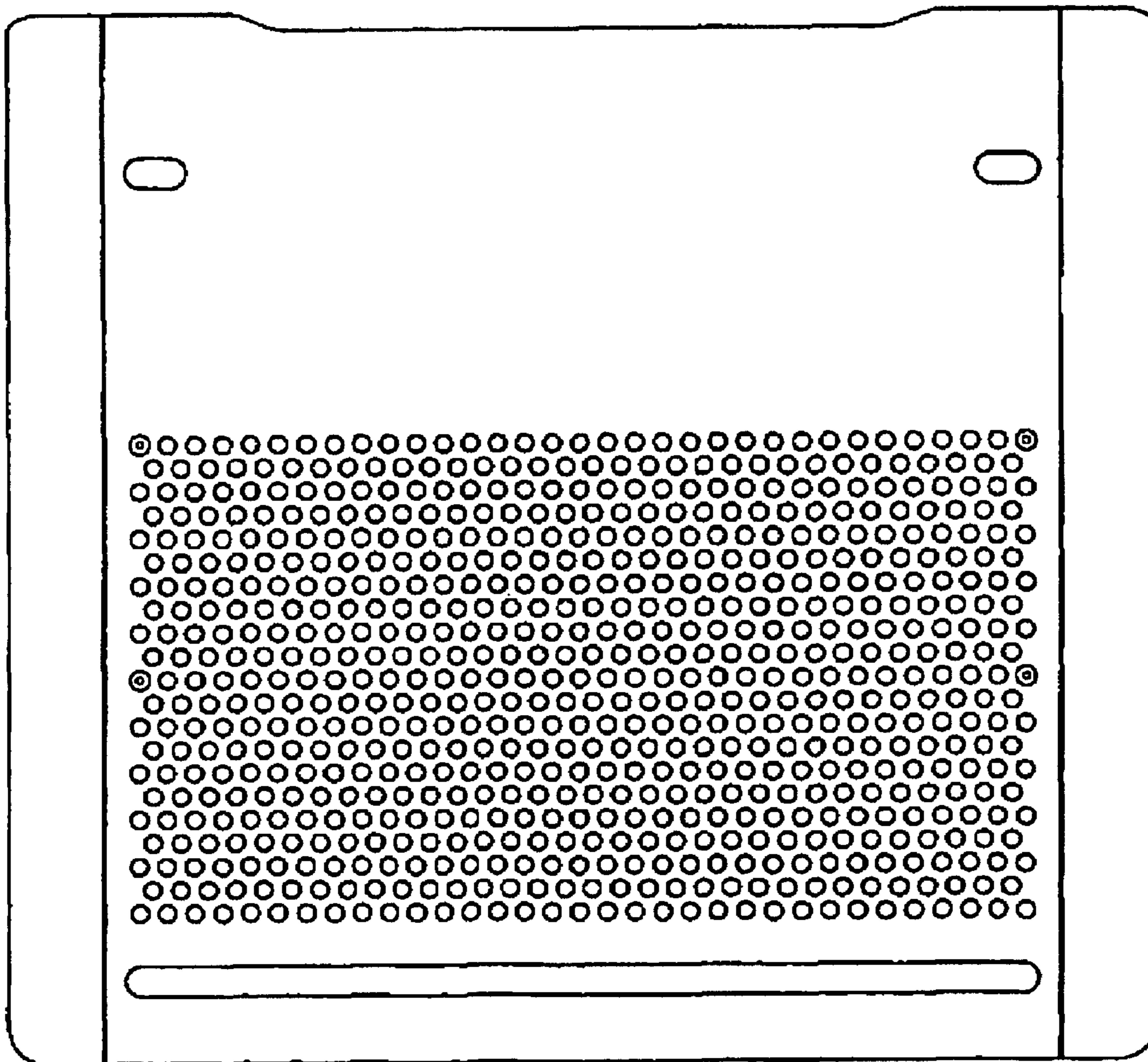


FIG. 5



FIG. 6



HEAT DISSIPATOR FOR A NOTEBOOK  
COMPUTER

FIG. 7

